

Hybrid (analog and digital) Silicon Tuner for terrestrial and cable TV reception

Rev. 2 — 11 August 2010

Product data sheet

1. General description

The TDA18272HN is a Silicon Tuner designed for terrestrial and cable TV reception for both analog and digital signals. TDA18272HN/M (Master) is to be used as a stand-alone tuner IC or Master in dual tuner application. TDA18272HN/S (Slave) is only to be used as Slave Silicon Tuner in dual tuner application.

The TDA18272HN supports all analog and digital TV standards and delivers a LOW IF (LIF) signal to a demodulator for analog TV and/or a channel demodulator for digital TV.

2. Features and benefits

- Fully integrated IF selectivity; eliminating the need for external SAW filters
- Worldwide multistandard terrestrial and cable
- Fully integrated oscillators
- Alignment free
- Single 3.3 V supply voltage
- Integrated wideband gain control
- Crystal oscillator output buffer (16 MHz) for single crystal applications
- I²C-bus interface compatible with 3.3 V microcontrollers
- Slave tuner output function to drive second (slave) Silicon Tuner
- Easy programming
- 5 ms tuning time
- LIF channel center frequency output ranging from 3 MHz to 5 MHz
- 1.7 MHz, 6 MHz, 7 MHz, 8 MHz and 10 MHz channel bandwidths
- Ready for DVB-T2
- RoHS compliant

3. Quick reference data

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{RF}	RF frequency	full range of RF input	42	-	870	MHz
NF _{tun}	tuner noise figure	75 Ω source; maximum gain	-	5.0	-	dB



NXP Semiconductors

Hybrid Silicon Tuner for terrestrial and cable TV reception

Table 1.	Quick reference data	continued				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Φjit	phase jitter	UHF; integrated from 250 Hz to 4 MHz	-	0.4	0.6	degree
α_{image}	image rejection	worst case for image rejection and 4 MHz IF frequency for levels above –50 dBm	57.5	63	-	dB
ICP _{1dB}	1 dB input compression point	at tuner input and minimum gain	124	-	-	dBμV

4. Ordering information

Table 2. Ordering information

Type number	Package		
	Name	Description	Version
TDA18272HN/M/C1 ^[1] HVQFN40		plastic thermal enhanced very thin quad flat	SOT618-1
TDA18272HN/S/C1[2]		package; no leads; 40 terminals; body $6 \times 6 \times 0.85$ mm	

[1] M for master.

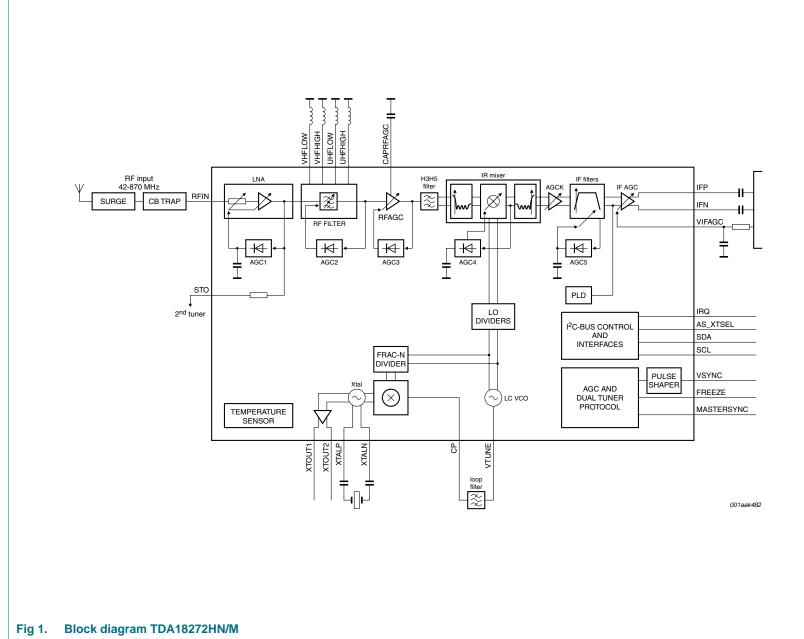
[2] S for slave.

NXP Semiconductors

TDA18272HN

Hybrid Silicon Tuner for terrestrial and cable TV reception

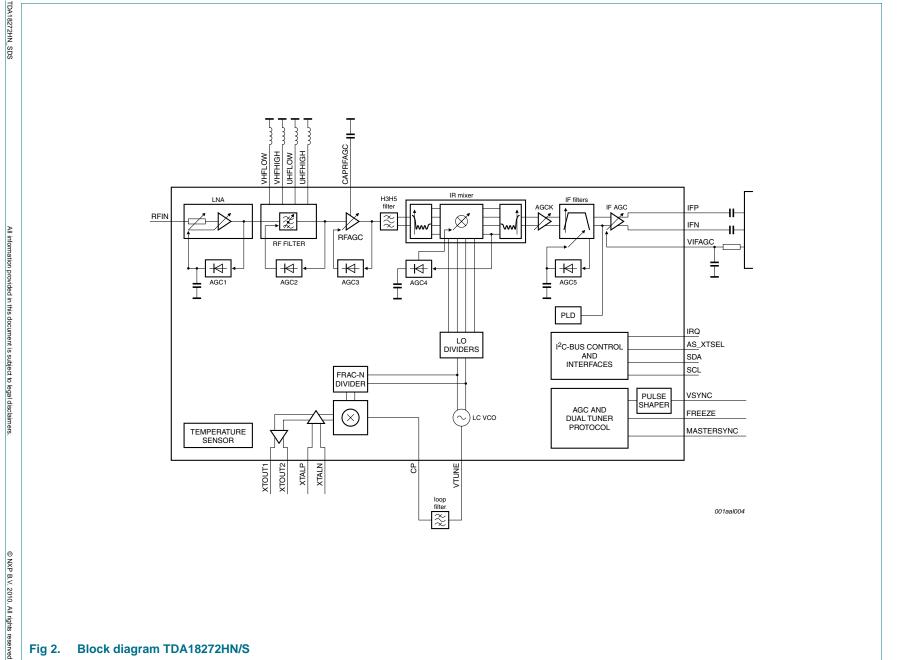
5. Block diagram



TDA18272HN_SDS
Product data sheet

All information provided in this document is subject to legal disclaimers
Rev. 2 — 11 August 2010

Rev. 2 — 11 August 2010



NXP Semiconductors

Hybrid Silicon Tuner for terrestrial and cable TV reception DA18272HN Hybrid Silicon Tuner for terrestrial and cable TV reception

6. Limiting values

Table 3. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.3	+3.6	V
V _I i	input voltage	pins SDA and SCL	-0.3	+3.6	V
		all other pins:			
		V_{CC} < 3.3 V	-0.3	V _{CC} + 0.3	V
		V _{CC} > 3.3 V	-0.3	+3.6	V
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C
T _{amb}	ambient temperature		-20	<u>[1]</u>	°C
V _{ESD}	electrostatic discharge voltage	EIA/JESD22-A114 (human body model)	-2	+2	kV
		EIA/JESD22-C101-C (FCDM) class III	750	-	V

[1] The maximum allowed ambient temperature $T_{amb(max)}$ depends on the assembly conditions of the package and especially on the design of the Printed-Circuit Board (PCB) and die connection. The application mounting must be done in such a way that the maximum junction temperature is never exceeded. The junction temperature can be obtained by reading the temperature sensor bit via I²C-bus. The junction temperature: $T_j = T_{amb} + \Delta T_{j-c}$. where $\Delta T_{j-c} = power \times R_{th}$.

[2] Class III: 500 V to 1000 V.

7. Abbreviations

Acronym	Description
AGC	Automatic Gain Control
GCK	Automatic Gain Control number K
В	Citizens' Band
VB	Digital Video Broadcasting
/B-T/T2/C/H	DVB-Terrestrial/Terrestrial second generation/Cable/Handheld
SD	ElectroStatic Discharge
CDM	Field-Induced Charged-Device Model
RAC-N	FRACtional-N
	Integrated Circuit
	Intermediate Frequency
Q	Interrupt ReQuest
-VCO	Inductors and Capacitors - Voltage Controlled Oscillator
IA	Low-Noise Amplifier
)	Local Oscillator
СВ	Printed Circuit Board
-	Radio Frequency
HS	Restriction on Hazardous Substances
W	Surface Acoustic Wave

NXP Semiconductors

TDA18272HN

Hybrid Silicon Tuner for terrestrial and cable TV reception

Table 4.	Abbreviations continued	
Acronym	Description	
STO	Slave Tuner Output	
UHF	Ultra High Frequency	
VCO	Voltage Controlled Oscillator	

8. Revision history

Table 5. Revision histo	ble 5. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes		
TDA18272HN_SDS v.2[1]	20100811	Product data sheet	-	-		

[1] Revision 1 is not available

9. Legal information

9.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

9.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

9.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from national authorities.

7 of 10

Hybrid Silicon Tuner for terrestrial and cable TV reception

Quick reference data — The Quick reference data is an extract of the product data given in the Limiting values and Characteristics sections of this document, and as such is not complete, exhaustive or legally binding.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

10. Contact information

9.4 Licenses

ICs with DVB-T or DVB-T2 functionality

Use of this product in any manner that complies with the DVB-T or the DVB-T2 standard may require licenses under applicable patents of the DVB-T respectively the DVB-T2 patent portfolio, which license is available from Sisvel S.p.A., Via Sestriere 100, 10060 None (TO), Italy, and under applicable patents of other parties.

9.5 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

I²C-bus — logo is a trademark of NXP B.V.

Silicon Tuner — is a trademark of NXP B.V.

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

Hybrid Silicon Tuner for terrestrial and cable TV reception

11. Tables

Table 1.	Quick reference data1
Table 2.	Ordering information2
Table 3.	Limiting values5

Table 4.	Abbreviations5
Table 5.	Revision history

12. Figures

Fig 1.	Block diagram TDA18272HN/M	3
Fig 2.	Block diagram TDA18272HN/S	4

NXP Semiconductors

TDA18272HN

Hybrid Silicon Tuner for terrestrial and cable TV reception

13. Contents

1	General description 1
2	Features and benefits 1
3	Quick reference data 1
4	Ordering information 2
5	Block diagram 3
6	Limiting values 5
7	Abbreviations 5
8	Revision history 6
9	Legal information 7
9.1	Data sheet status 7
9.2	Definitions7
9.3	Disclaimers
9.4	Licenses
9.5	Trademarks
10	Contact information 8
11	Tables
12	Figures 9
13	Contents 10

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP B.V. 2010.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 11 August 2010 Document identifier: TDA18272HN_SDS